

Abstract of Disclosure

A package method of a LED containing a phosphoric medium is utilizing a liquid phosphoric glue as material and utilizing a casting
5 mold method to encapsulate. During the package process, the liquid phosphoric glue is saturated and the phosphor is precipitated to cover the LED unit for providing a LED package with a phosphoric medium layer cover the LED unit. The phosphoric medium layer is composed of a package glue and a phosphor layer precipitated on
10 bottom to compactly cover the LED unit. The claimed invention can reduce the light-color leakage rate of the LED, standardize the size, stabilize the white-light spectrum, improve the yield and reduce the cost.

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